



STP40N20

STB40N20 - STW40N20

N-CHANNEL 200V - 0.038Ω - 40A TO-220/TO-247/D²PAK

LOW GATE CHARGE STripFET™ MOSFET

Table 1: General Features

| TYPE | V _{DSS} | R _{DS(on)} | I _D | P _w |
|----------|------------------|---------------------|----------------|----------------|
| STP40N20 | 200 V | < 0.045 Ω | 40 A | 160 W |
| STW40N20 | 200 V | < 0.045 Ω | 40 A | 160 W |
| STB40N20 | 200 V | < 0.045 Ω | 40 A | 160 W |

- TYPICAL R_{DS(on)} = 0.038 Ω
- GATE CHARGE MINIMIZED
- VERY LOW INTRINSIC CAPACITANCES
- VERY GOOD MANUFACTURING REPEATABILITY
- EXCELLENT FIGURE OF MERIT (R_{DS}*Q_g)
- 100% AVALANCHE TESTED

DESCRIPTION

This MOSFET series realized with STMicroelectronics unique STripFET process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced high-efficiency isolated DC-DC converters.

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- UPS

Figure 1: Package

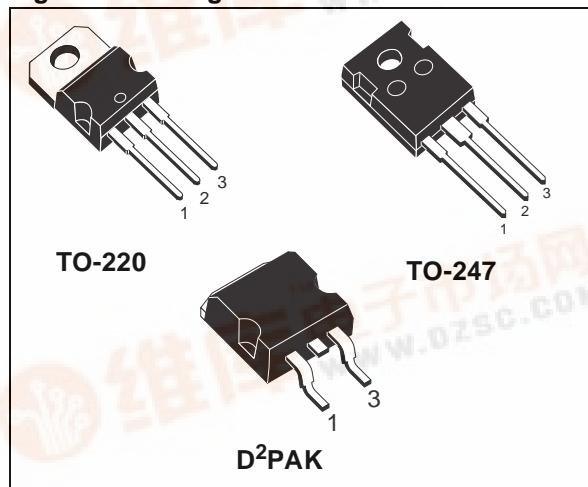


Figure 2: Internal Schematic Diagram

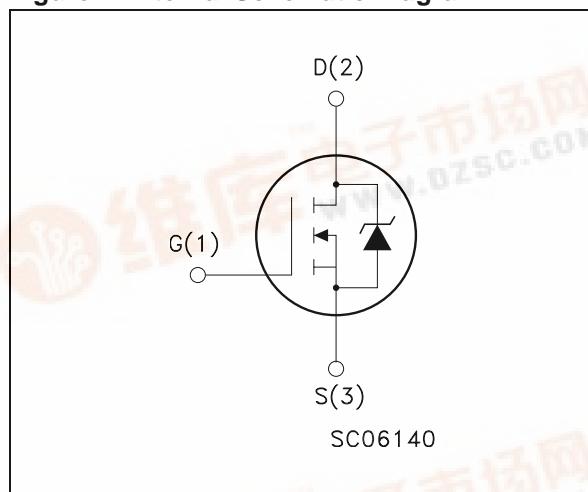


Table 2: Order Codes

| SALES TYPE | MARKING | PACKAGE | PACKAGING |
|------------|---------|--------------------|-------------|
| STP40N20 | P40N20 | TO-220 | TUBE |
| STW40N20 | W40N20 | TO-247 | TUBE |
| STB40N20 | B40N20 | D ² PAK | TAPE & REEL |

STB40N20 - STP40N20 - STW40N20

Table 3: Absolute Maximum ratings

| Symbol | Parameter | Value | Unit |
|--------------------|---|------------|---------------------|
| V_{DS} | Drain-source Voltage ($V_{GS} = 0$) | 200 | V |
| V_{DGR} | Drain-gate Voltage ($R_{GS} = 20 \text{ k}\Omega$) | 200 | V |
| V_{GS} | Gate- source Voltage | ± 20 | V |
| I_D | Drain Current (continuous) at $T_C = 25^\circ\text{C}$ | 40 | A |
| I_D | Drain Current (continuous) at $T_C = 100^\circ\text{C}$ | 25 | A |
| $I_{DM} (\bullet)$ | Drain Current (pulsed) | 160 | A |
| P_{TOT} | Total Dissipation at $T_C = 25^\circ\text{C}$ | 160 | W |
| | Derating Factor | 1.28 | W/ $^\circ\text{C}$ |
| dv/dt (1) | Peak Diode Recovery voltage slope | 12 | V/ns |
| T_j T_{stg} | Operating Junction Temperature Storage Temperature | -55 to 150 | $^\circ\text{C}$ |

(•) Pulse width limited by safe operating area

(1) $I_{SD} \leq 40\text{A}$, $di/dt \leq 200 \text{ A}/\mu\text{s}$, $V_{DD} \leq V_{(\text{BR})DSS}$, $T_j \leq T_{JMAX}$.

Table 4: Thermal Data

| | | TO-220/ | TO-247 | |
|----------------|--|---------|--------|--------------------|
| $R_{thj-case}$ | Thermal Resistance Junction-case Max | | 0.78 | $^\circ\text{C/W}$ |
| $R_{thj-amb}$ | Thermal Resistance Junction-ambient Max | 62.5 | 50 | $^\circ\text{C/W}$ |
| T_I | Maximum Lead Temperature For Soldering Purpose | | 300 | $^\circ\text{C}$ |

Table 5: Avalanche Characteristics

| Symbol | Parameter | Max Value | Unit |
|----------|---|-----------|------|
| I_{AR} | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T_j max) | 40 | A |
| E_{AS} | Single Pulse Avalanche Energy (starting $T_j = 25^\circ\text{C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$) | 230 | mJ |

STB40N20 - STP40N20 - STW40N20

ELECTRICAL CHARACTERISTICS ($T_{CASE} = 25^\circ C$ UNLESS OTHERWISE SPECIFIED)

Table 6: On/Off

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------|--|--|------|-------|-----------|--------------------|
| $V_{(BR)DSS}$ | Drain-source Breakdown Voltage | $I_D = 1\text{mA}$, $V_{GS} = 0$ | 200 | | | V |
| I_{DSS} | Zero Gate Voltage Drain Current ($V_{GS} = 0$) | $V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating}$, $T_C = 125^\circ C$ | | | 1 10 | μA μA |
| I_{GSS} | Gate-body Leakage Current ($V_{DS} = 0$) | $V_{GS} = \pm 20V$ | | | ± 100 | nA |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}$, $I_D = 250\text{\mu A}$ | 2 | 3 | 4 | V |
| $R_{DS(on)}$ | Static Drain-source On Resistance | $V_{GS} = 10V$, $I_D = 20\text{ A}$ | | 0.038 | 0.045 | Ω |

Table 7: Dynamic

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|--|------|----------------------|------|----------------------|
| $g_{fs}(1)$ | Forward Transconductance | $V_{DS} = 15\text{ V}$, $I_D=20\text{ A}$ | | 30 | | S |
| C_{iss} C_{oss} C_{rss} | Input Capacitance Output Capacitance Reverse Transfer Capacitance | $V_{DS} = 25\text{V}$, $f = 1\text{ MHz}$, $V_{GS} = 0$ | | 2500 510 78 | | pF pF pF |
| $t_{d(on)}$ t_r $t_{d(off)}$ t_f | Turn-on Delay Time Rise Time Turn-off Delay Time Fall Time | $V_{DD} = 100\text{ V}$, $I_D = 20\text{ A}$, $R_G = 4.7\text{ }\Omega$ $V_{GS} = 10\text{ V}$ (Resistive Load see, Figure 17) | | 20 44 74 22 | | ns ns ns ns |
| Q_g Q_{gs} Q_{gd} | Total Gate Charge Gate-Source Charge Gate-Drain Charge | $V_{DD} = 160\text{V}$, $I_D = 40\text{ A}$, $V_{GS} = 10\text{V}$ | | 75 13.2 35.5 | | nC nC nC |

Table 8: Source Drain Diode

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-----------------------------------|--|---|------|---------------------|-----------|---------------|
| I_{SD} $I_{SDM}(2)$ | Source-drain Current Source-drain Current (pulsed) | | | | 40 160 | A A |
| $V_{SD}(1)$ | Forward On Voltage | $I_{SD} = 20\text{ A}$, $V_{GS} = 0$ | | | 1.5 | V |
| t_{rr} Q_{rr} I_{RRM} | Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current | $I_{SD} = 20\text{ A}$, $di/dt = 100\text{A}/\mu s$ $V_{DD} = 100\text{V}$, $T_j = 25^\circ C$ (see test circuit, Figure 18) | | 192 922 9.6 | | ns nC A |
| t_{rr} Q_{rr} I_{RRM} | Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current | $I_{SD} = 20\text{ A}$, $di/dt = 100\text{A}/\mu s$ $V_{DD} = 100\text{V}$, $T_j = 150^\circ C$ (see test circuit, Figure 18) | | 242 1440 11.9 | | ns nC A |

(1) Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %.

(2) Pulse width limited by safe operating area.

STB40N20 - STP40N20 - STW40N20

Figure 3: Safe Operating Area For TO-220/D²PAK

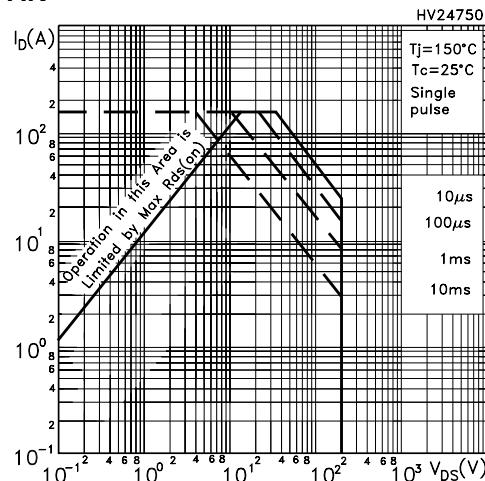


Figure 4: Safe Operating Area For TO-247

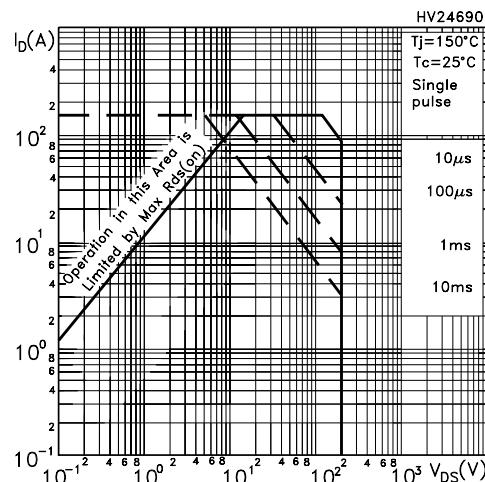


Figure 5: Output Characteristics

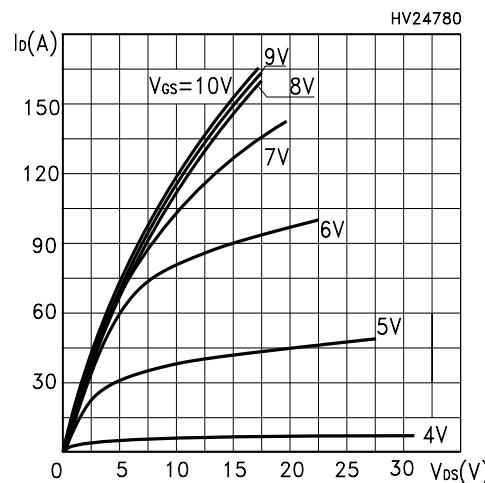


Figure 6: Thermal Impedance For TO-220/D²PAK

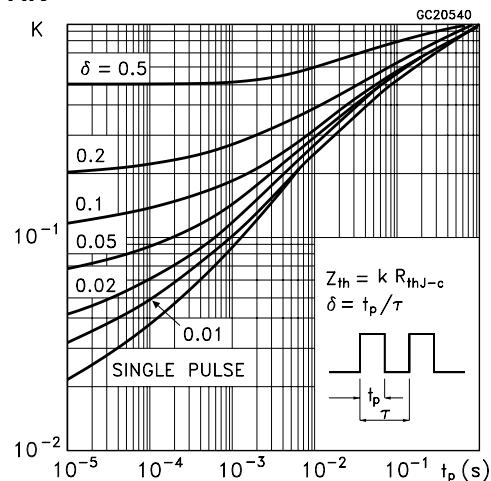


Figure 7: Thermal Impedance For TO-247

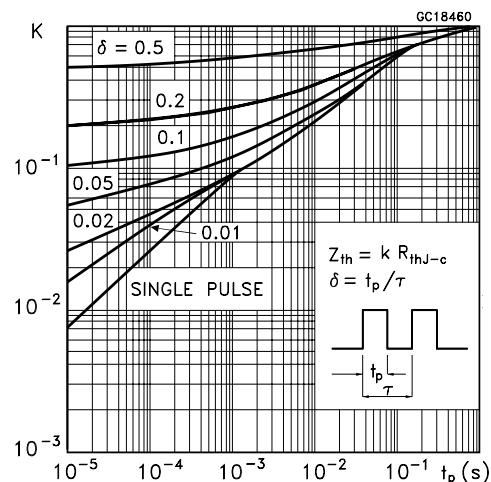
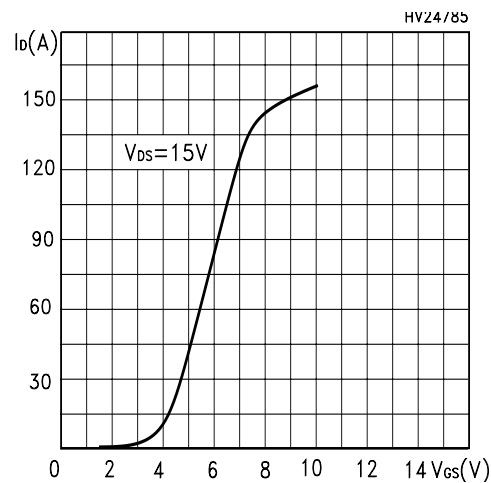


Figure 8: Transfer Characteristics



STB40N20 - STP40N20 - STW40N20

Figure 9: Transconductance

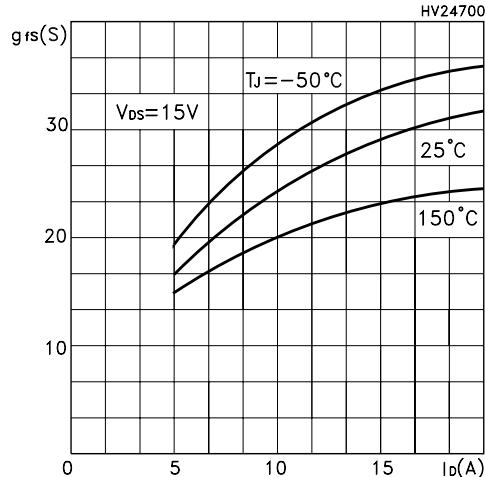


Figure 10: Gate Charge vs Gate-source Voltage

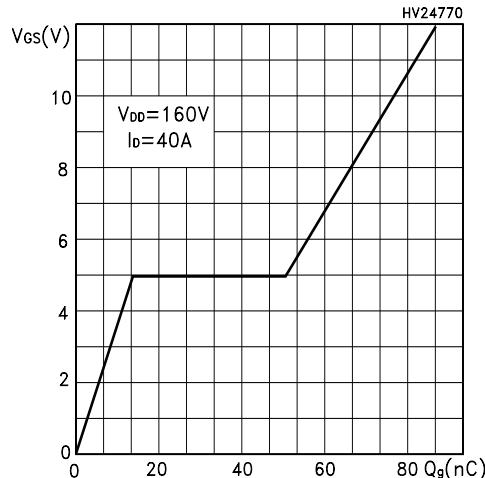


Figure 11: Normalized Gate Threshold Voltage vs Temperature

Figure 12: Static Drain-source On Resistance

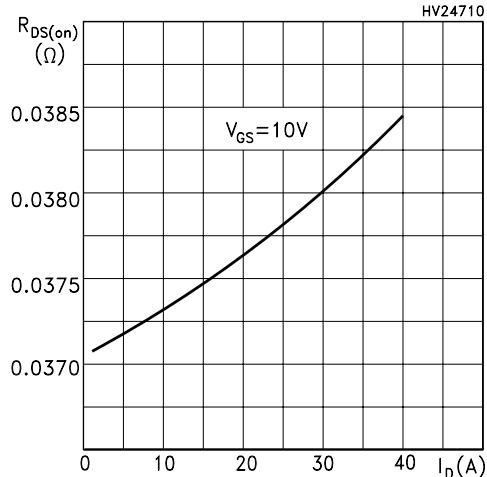


Figure 13: Capacitance Variations

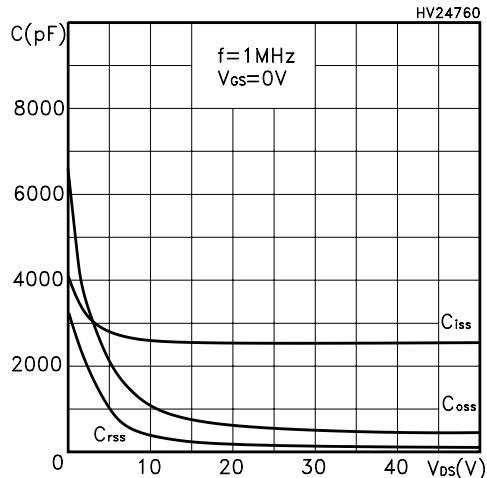
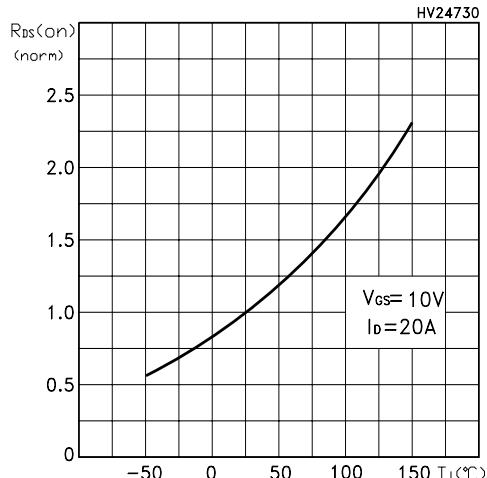
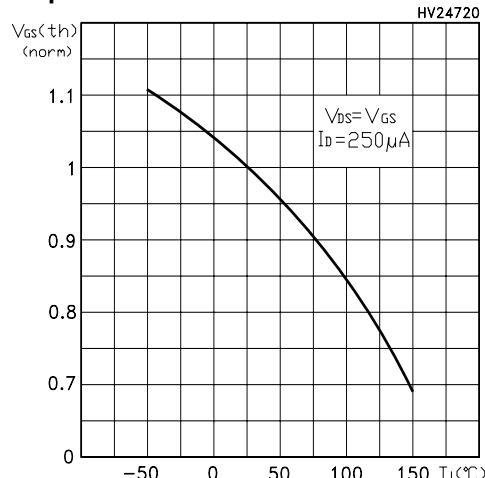
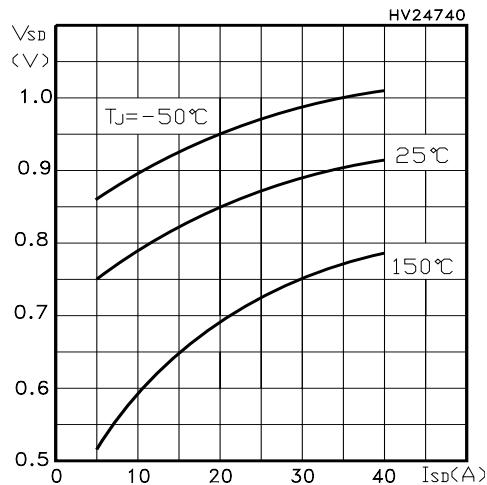


Figure 14: Normalized On Resistance vs Temperature



STB40N20 - STP40N20 - STW40N20

Figure 15: Source-Drain Forward Characteristics



STB40N20 - STP40N20 - STW40N20

Figure 16: Unclamped Inductive Load Test Circuit

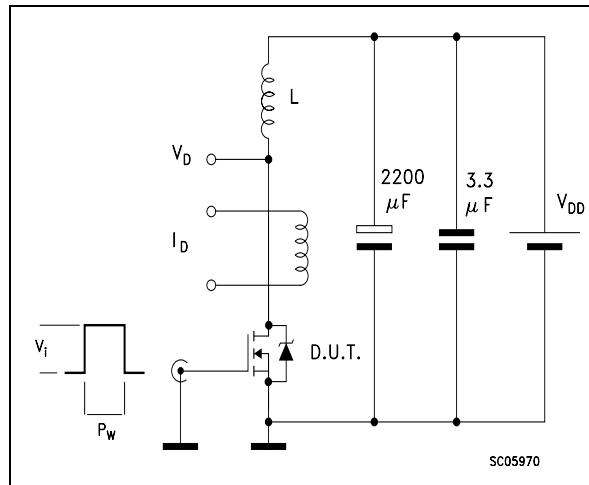


Figure 17: Switching Times Test Circuit For Resistive Load

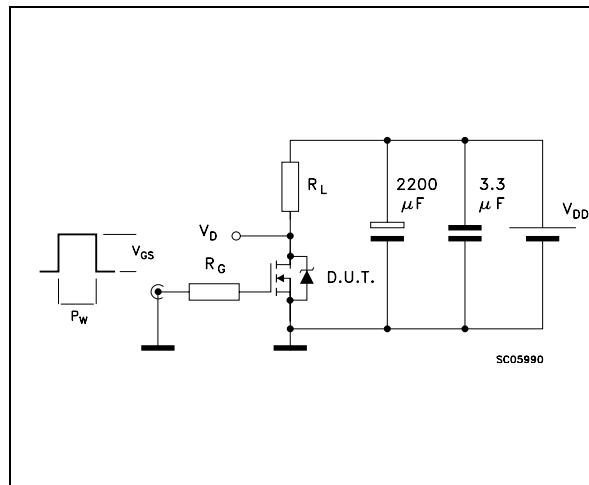


Figure 18: Test Circuit For Inductive Load Switching and Diode Recovery Times

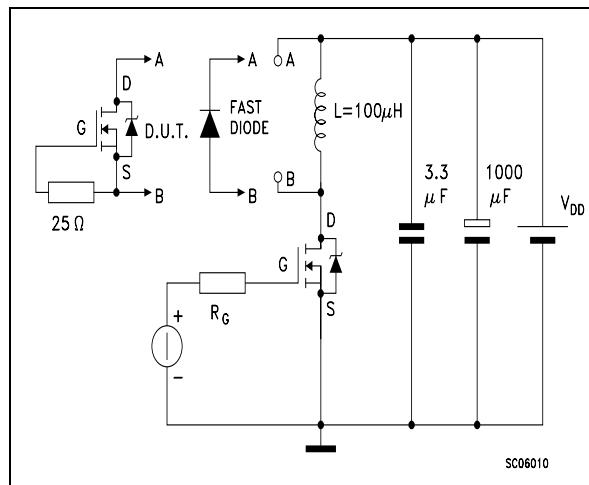


Figure 19: Unclamped Inductive Waveform

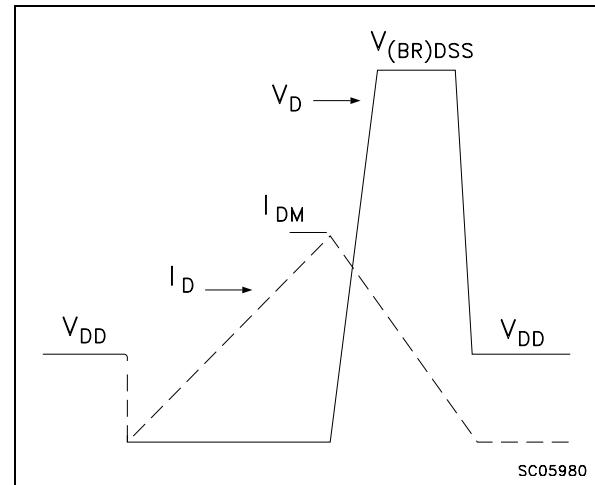
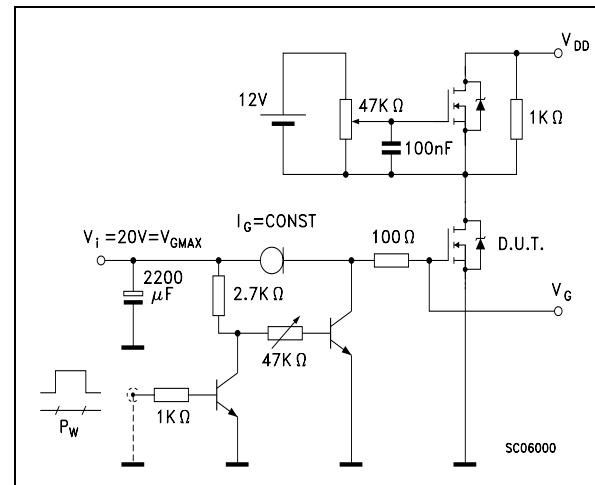


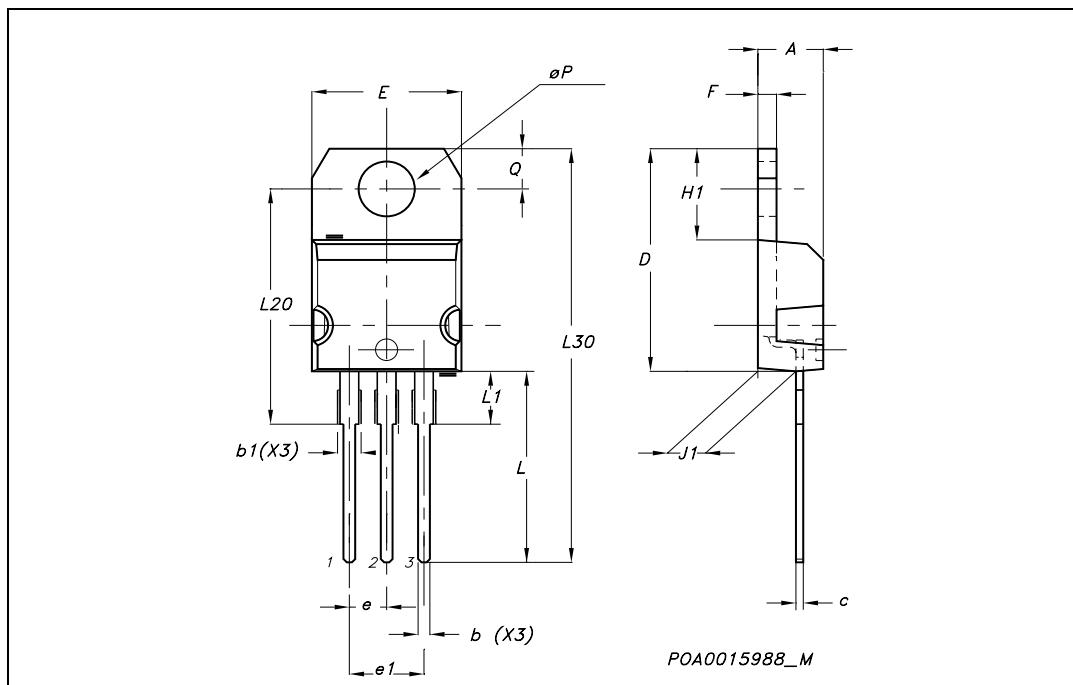
Figure 20: Gate Charge Test Circuit



STB40N20 - STP40N20 - STW40N20

TO-220 MECHANICAL DATA

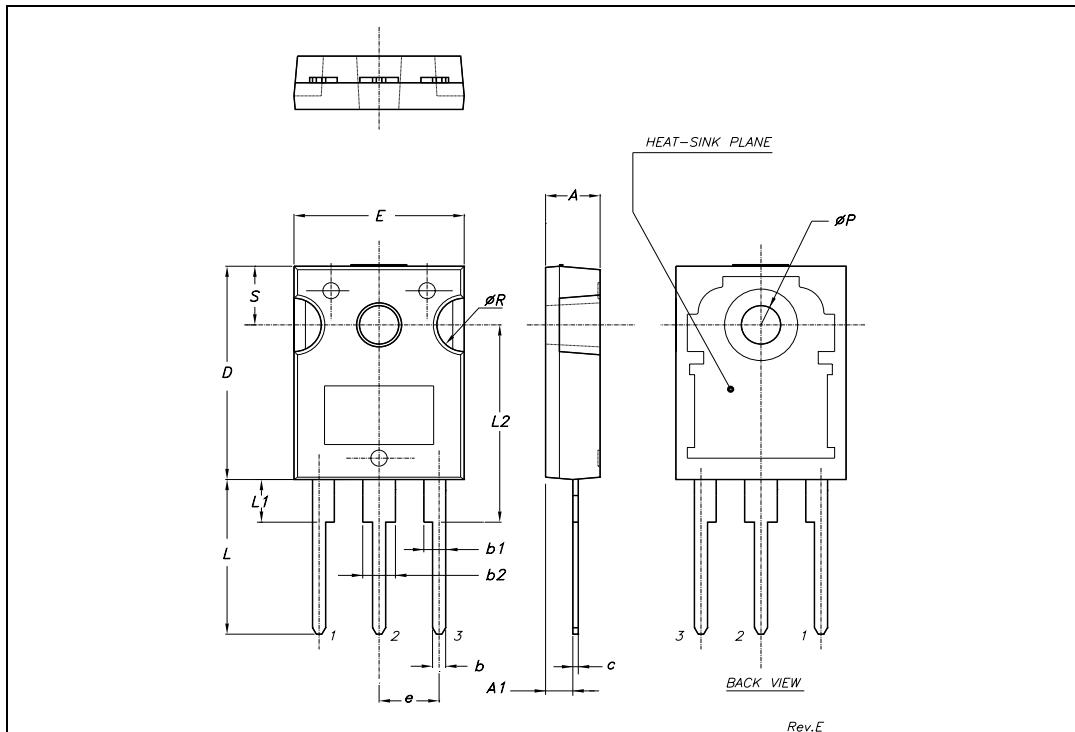
| DIM. | mm. | | | inch | | |
|----------|-------|-------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 4.40 | | 4.60 | 0.173 | | 0.181 |
| b | 0.61 | | 0.88 | 0.024 | | 0.034 |
| b1 | 1.15 | | 1.70 | 0.045 | | 0.066 |
| c | 0.49 | | 0.70 | 0.019 | | 0.027 |
| D | 15.25 | | 15.75 | 0.60 | | 0.620 |
| E | 10 | | 10.40 | 0.393 | | 0.409 |
| e | 2.40 | | 2.70 | 0.094 | | 0.106 |
| e1 | 4.95 | | 5.15 | 0.194 | | 0.202 |
| F | 1.23 | | 1.32 | 0.048 | | 0.052 |
| H1 | 6.20 | | 6.60 | 0.244 | | 0.256 |
| J1 | 2.40 | | 2.72 | 0.094 | | 0.107 |
| L | 13 | | 14 | 0.511 | | 0.551 |
| L1 | 3.50 | | 3.93 | 0.137 | | 0.154 |
| L20 | | 16.40 | | | 0.645 | |
| L30 | | 28.90 | | | 1.137 | |
| ϕP | 3.75 | | 3.85 | 0.147 | | 0.151 |
| Q | 2.65 | | 2.95 | 0.104 | | 0.116 |



STB40N20 - STP40N20 - STW40N20

TO-247 MECHANICAL DATA

| DIM. | mm. | | | inch | | |
|----------|-------|-------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 4.85 | | 5.15 | 0.19 | | 0.20 |
| A1 | 2.20 | | 2.60 | 0.086 | | 0.102 |
| b | 1.0 | | 1.40 | 0.039 | | 0.055 |
| b1 | 2.0 | | 2.40 | 0.079 | | 0.094 |
| b2 | 3.0 | | 3.40 | 0.118 | | 0.134 |
| c | 0.40 | | 0.80 | 0.015 | | 0.03 |
| D | 19.85 | | 20.15 | 0.781 | | 0.793 |
| E | 15.45 | | 15.75 | 0.608 | | 0.620 |
| e | | 5.45 | | | 0.214 | |
| L | 14.20 | | 14.80 | 0.560 | | 0.582 |
| L1 | 3.70 | | 4.30 | 0.14 | | 0.17 |
| L2 | | 18.50 | | | 0.728 | |
| ϕP | 3.55 | | 3.65 | 0.140 | | 0.143 |
| ϕR | 4.50 | | 5.50 | 0.177 | | 0.216 |
| S | | 5.50 | | | 0.216 | |

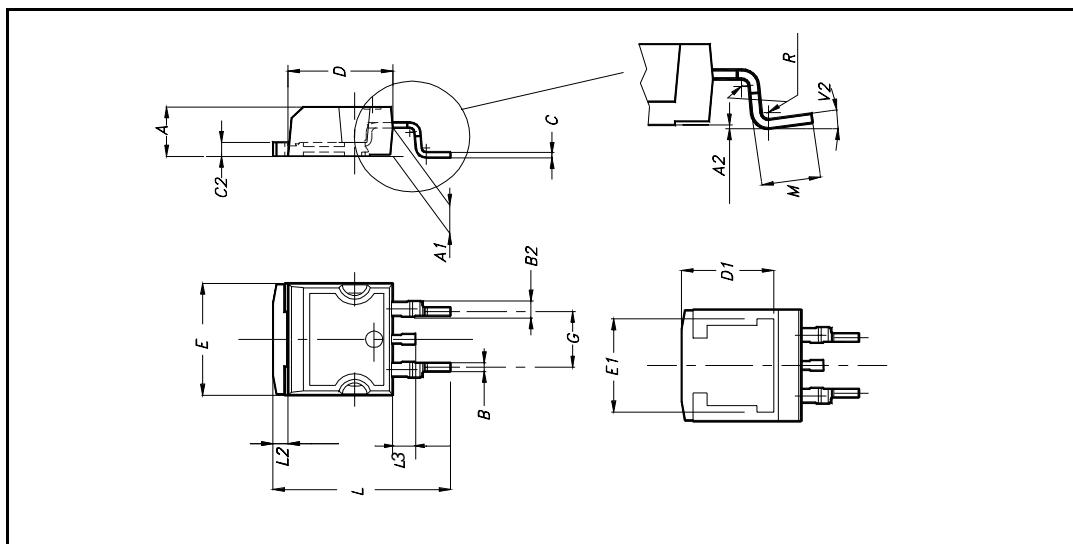


Rev.E

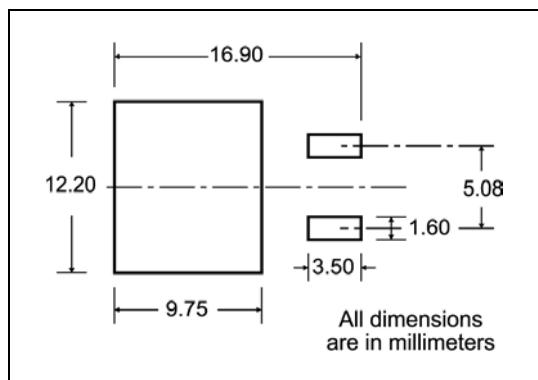
STB40N20 - STP40N20 - STW40N20

D²PAK MECHANICAL DATA

| DIM. | mm. | | | inch | | |
|------|------|------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 4.4 | | 4.6 | 0.173 | | 0.181 |
| A1 | 2.49 | | 2.69 | 0.098 | | 0.106 |
| A2 | 0.03 | | 0.23 | 0.001 | | 0.009 |
| B | 0.7 | | 0.93 | 0.027 | | 0.036 |
| B2 | 1.14 | | 1.7 | 0.044 | | 0.067 |
| C | 0.45 | | 0.6 | 0.017 | | 0.023 |
| C2 | 1.23 | | 1.36 | 0.048 | | 0.053 |
| D | 8.95 | | 9.35 | 0.352 | | 0.368 |
| D1 | | 8 | | | 0.315 | |
| E | 10 | | 10.4 | 0.393 | | |
| E1 | | 8.5 | | | 0.334 | |
| G | 4.88 | | 5.28 | 0.192 | | 0.208 |
| L | 15 | | 15.85 | 0.590 | | 0.625 |
| L2 | 1.27 | | 1.4 | 0.050 | | 0.055 |
| L3 | 1.4 | | 1.75 | 0.055 | | 0.068 |
| M | 2.4 | | 3.2 | 0.094 | | 0.126 |
| R | | 0.4 | | | 0.015 | |
| V2 | 0° | | 4° | | | |



D²PAK FOOTPRINT



TAPE AND REEL SHIPMENT

| REEL MECHANICAL DATA | | | | |
|----------------------|------|------|-------|--------|
| DIM. | mm | inch | | |
| | MIN. | MAX. | MIN. | MAX. |
| A | | | 330 | 12.992 |
| B | 1.5 | | 0.059 | |
| C | 12.8 | 13.2 | 0.504 | 0.520 |
| D | 20.2 | | 0795 | |
| G | 24.4 | 26.4 | 0.960 | 1.039 |
| N | 100 | | 3.937 | |
| T | | 30.4 | | 1.197 |

| BASE QTY | BULK QTY |
|----------|----------|
| 1000 | 1000 |

The diagram illustrates the tape slot configuration in the reel core. It shows a circular reel with a slot of 2.5 mm minimum width and a full radius. The access hole is 40 mm minimum. Dimensions A, B, C, D, G, N, and T are indicated. A separate table provides detailed mechanical data for the tape itself.

| DIM. | mm | | inch | |
|------|------|------|--------|--------|
| | MIN. | MAX. | MIN. | MAX. |
| A0 | 10.5 | 10.7 | 0.413 | 0.421 |
| B0 | 15.7 | 15.9 | 0.618 | 0.626 |
| D | 1.5 | 1.6 | 0.059 | 0.063 |
| D1 | 1.59 | 1.61 | 0.062 | 0.063 |
| E | 1.65 | 1.85 | 0.065 | 0.073 |
| F | 11.4 | 11.6 | 0.449 | 0.456 |
| K0 | 4.8 | 5.0 | 0.189 | 0.197 |
| P0 | 3.9 | 4.1 | 0.153 | 0.161 |
| P1 | 11.9 | 12.1 | 0.468 | 0.476 |
| P2 | 1.9 | 2.1 | 0.075 | 0.082 |
| R | 50 | | 1.574 | |
| T | 0.25 | 0.35 | 0.0098 | 0.0137 |
| W | 23.7 | 24.3 | 0.933 | 0.956 |

* on sales type

STB40N20 - STP40N20 - STW40N20

Table 9: Revision History

| Date | Revision | Description of Changes |
|-------------|----------|--------------------------------|
| 27-Sep-2004 | 1 | First Release. |
| 03-Feb-2005 | 2 | Complete Version |
| 03-Jun-2005 | 3 | Update with D ² PAK |

STB40N20 - STP40N20 - STW40N20

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics

All other names are the property of their respective owners

© 2005 STMicroelectronics - All Rights Reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -
Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America